



P-Channel 12-V (D-S) MOSFET

PRODUCT SUMMARY

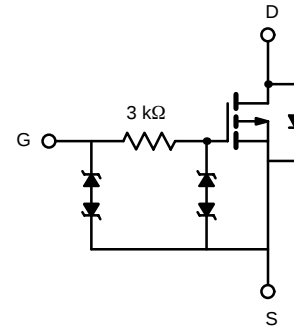
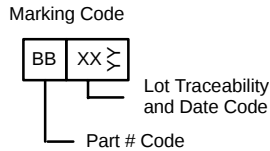
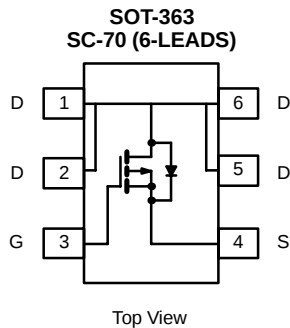
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
-12	0.085 @ $V_{GS} = -4.5$ V	-3.3
	0.115 @ $V_{GS} = -2.5$ V	-2.9
	0.160 @ $V_{GS} = -1.8$ V	-2.4

FEATURES

- TrenchFET® Power MOSFETS: 1.8-V Rated
- ESD Protected: 3000 V
- Thermally Enhanced SC-70 Package

APPLICATIONS

- Load Switching
- PA Switch
- Level Switch

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter		Symbol	5 secs	Steady State	Unit
Drain-Source Voltage		V _{DS}	−12		V
Gate-Source Voltage		V _{GS}	± 12		
Continuous Drain Current (T _J = 150°C) ^a	T _A = 25°C	I _D	−3.3	−2.7	A
	T _A = 85°C		−2.4	−1.9	
Pulsed Drain Current		I _{DM}	−8		
Continuous Diode Current (Diode Conduction) ^a		I _S	−1.4	−0.9	W
Maximum Power Dissipation ^a	T _A = 25°C	P _D	1.56	1.0	
	T _A = 85°C		0.81	0.52	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	−55 to 150		°C

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	$t \leq 5$ sec	R_{thJA}	60	80	$^\circ\text{C/W}$
	Steady State		100	125	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	34	45	

Notes

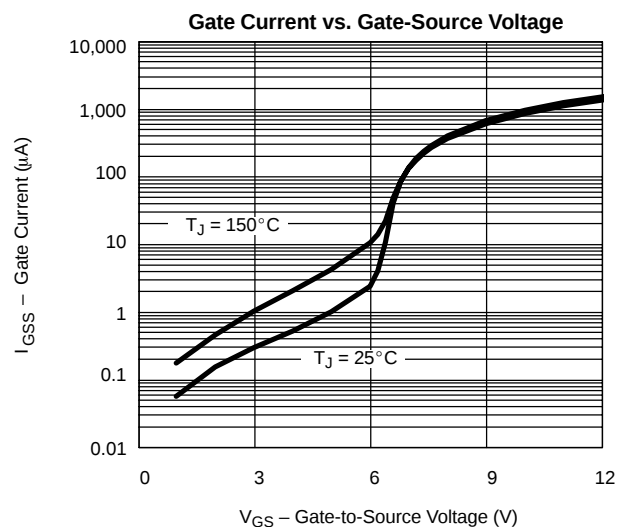
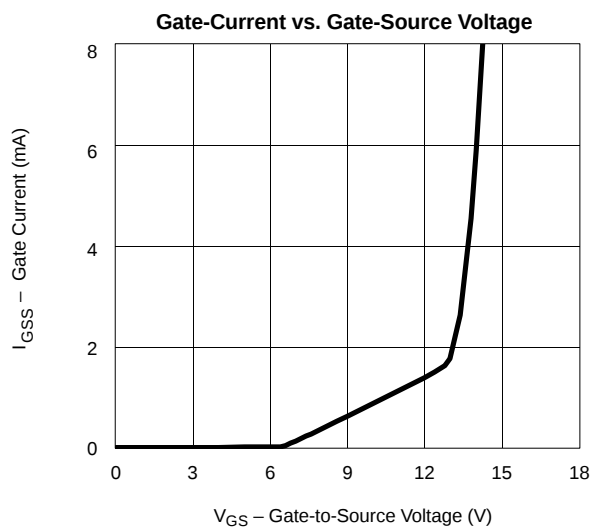
a. Surface Mounted on 1" x 1" FR4 Board.

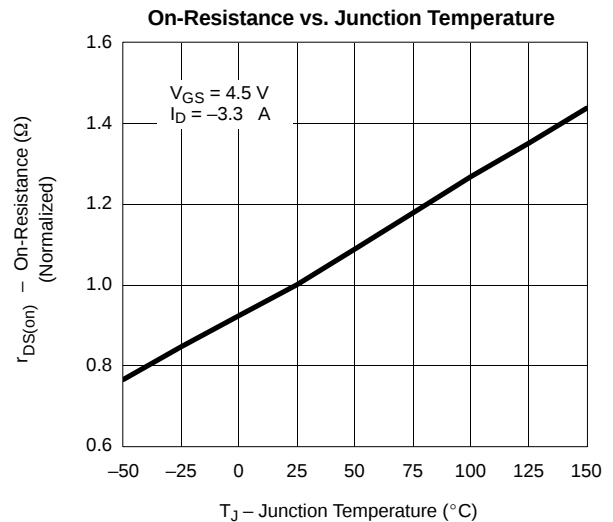
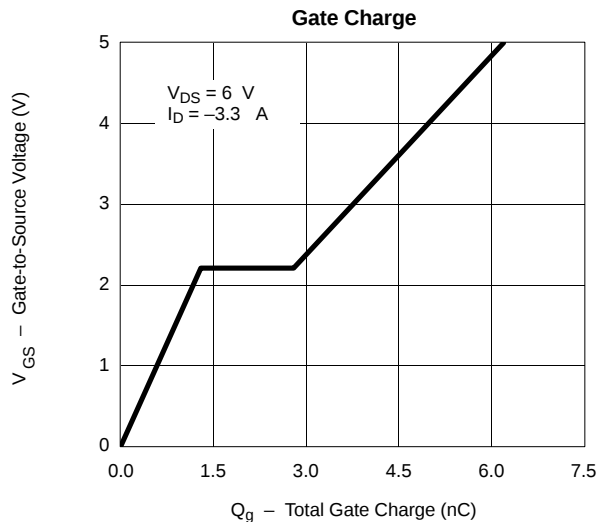
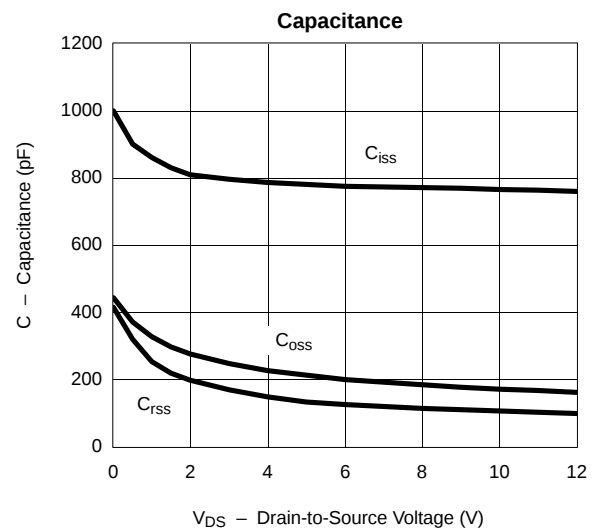
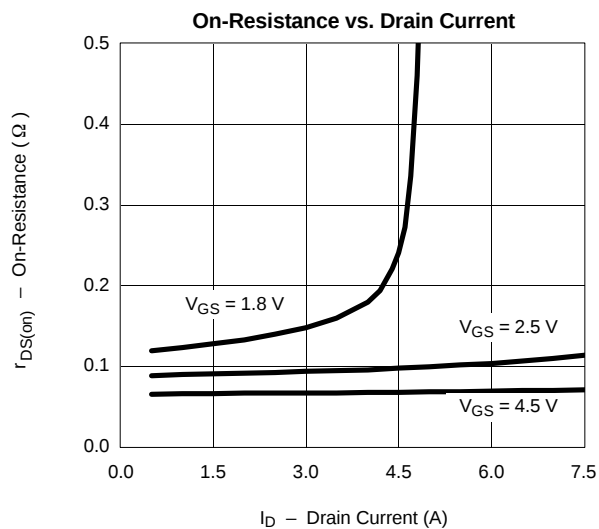
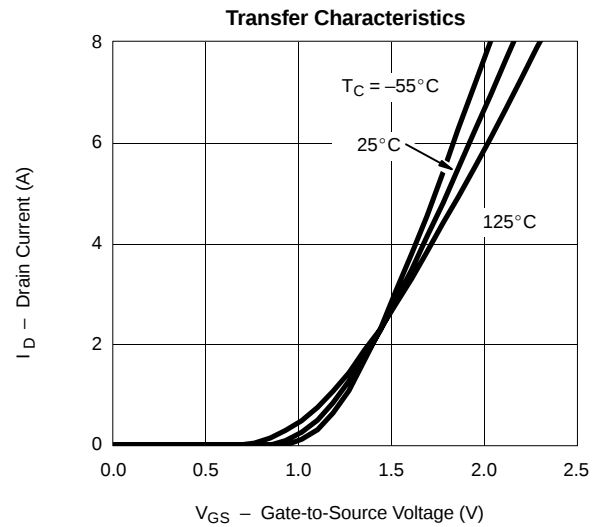
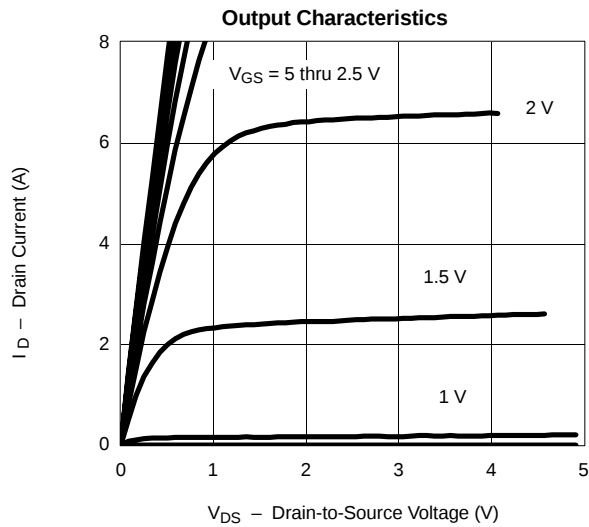
SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

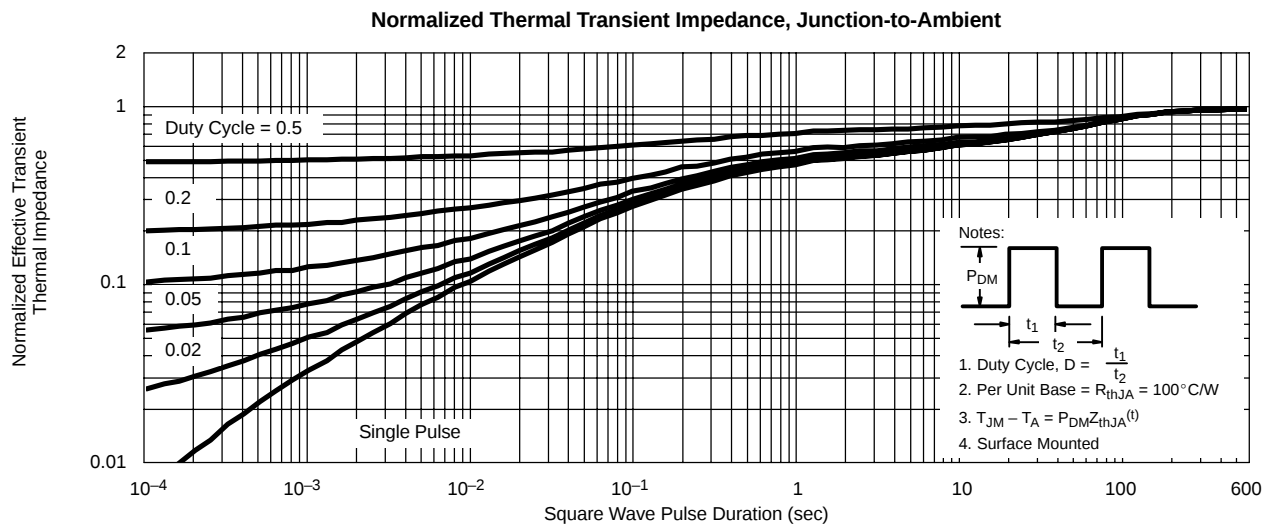
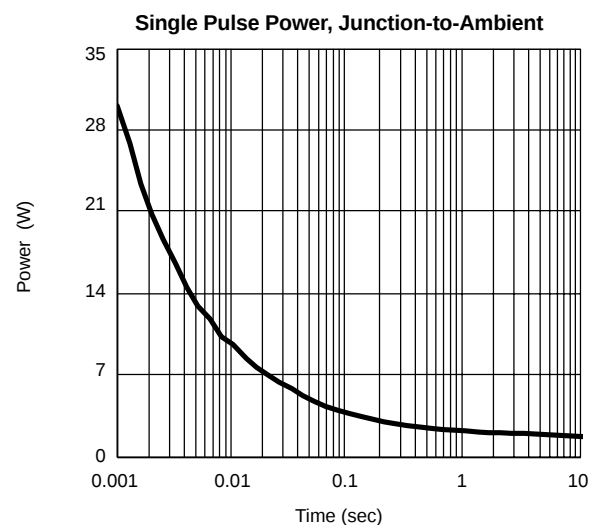
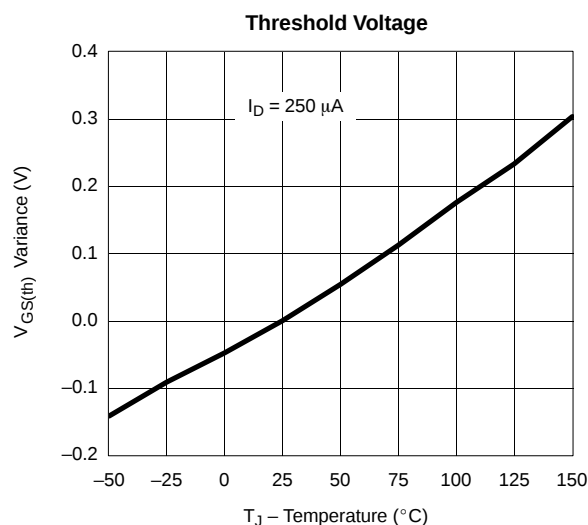
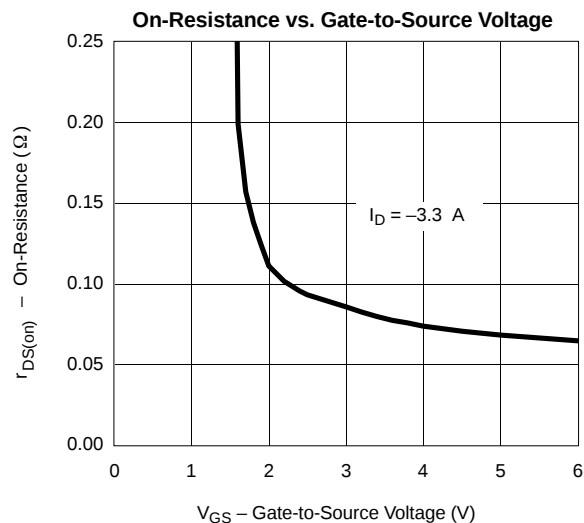
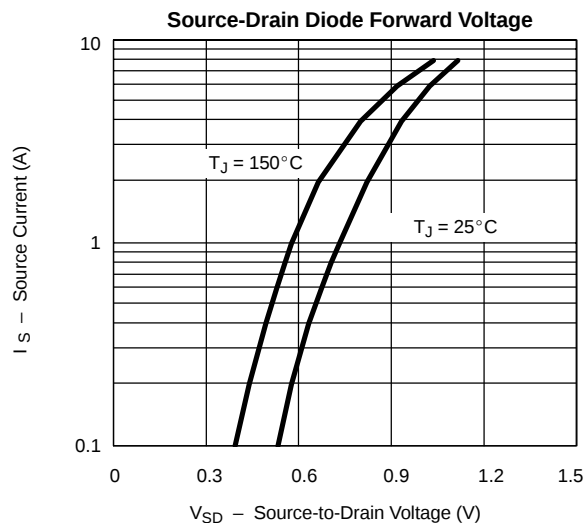
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = -250\ \mu\text{A}$	-0.45			V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\ \text{V}$, $V_{GS} = \pm 4.5\ \text{V}$			± 1.5	μA
		$V_{DS} = 0\ \text{V}$, $V_{GS} = \pm 12\ \text{V}$			± 10	mA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -9.6\ \text{V}$, $V_{GS} = 0\ \text{V}$			-1	μA
		$V_{DS} = -9.6\ \text{V}$, $V_{GS} = 0\ \text{V}$, $T_J = 85^\circ\text{C}$			-5	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} = -5\ \text{V}$, $V_{GS} = -4.5\ \text{V}$	-4			A
Drain-Source On-State Resistance ^a	$r_{DS(on)}$	$V_{GS} = -4.5\ \text{V}$, $I_D = -3.3\ \text{A}$		0.070	0.085	Ω
		$V_{GS} = -2.5\ \text{V}$, $I_D = -2.9\ \text{A}$		0.095	0.115	
		$V_{GS} = -1.8\ \text{V}$, $I_D = -1.0\ \text{A}$		0.133	0.160	
Forward Transconductance ^a	g_{fs}	$V_{DS} = -10\ \text{V}$, $I_D = -3.3\ \text{A}$		8		S
Diode Forward Voltage ^a	V_{SD}	$I_S = -1.4\ \text{A}$, $V_{GS} = 0\ \text{V}$		-0.80	-1.1	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = -6\ \text{V}$, $V_{GS} = -4.5\ \text{V}$, $I_D = -3.3\ \text{A}$		5.8	8	nC
Gate-Source Charge	Q_{gs}			1.3		
Gate-Drain Charge	Q_{gd}			1.5		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -6\ \text{V}$, $R_L = 6\ \Omega$ $I_D \cong -1\ \text{A}$, $V_{GEN} = -4.5\ \text{V}$, $R_G = 6\ \Omega$		0.60	1.0	μs
Rise Time	t_r			1.4	2.1	
Turn-Off Delay Time	$t_{d(off)}$			4.9	7.5	
Fall Time	t_f			4.9	7.5	

Notes

- a. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

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